PCN Number:		20211206000.1								PCN D	ate:	December 13,	
			addition	not made compound for colors devices						2021			
Customer Contact: PCN Manager				Dept: Quality Servi									
Proposed 1 st Ship Date: Mar 1			Mar 13	3 2022		LS			lability: sample request				
Change Type:													
	embly Sit	e			Design					Wafer Bump Site			
Assembly Process				Data Sheet					Wafer Bump Material				
Assembly Materials				Part number change				Ц	Wafer Bump Process				
Mechanical Specification					Test Site				<u> </u>	Wafer Fab Site			
Packing/Shipping/Labeling			ng	Test Process				+	Wafer Fab Materials Wafer Fab Process				
PCN Details								Process					
Descrip	tion of C	hange	a !			CIT	Details						
This PCN is to inform of the qualification of an additional mold compound for the devices in the product affected section as follows:													
	Cur	rent M	lold	Compo	unds		Additional Mold Compound						
	SID#4	10200	26A3	or SI	D#R-1	2		SID#40	20	70106			
Reason	for Chai	nge:											
Mold Cor	mpound 9	Supplie	r EOI	L									
Anticipa	ated imp	act or	For	m, Fit,	Functi	ion,	Quality o	r Reliat	oilit	y (pos	sitive	/ negative):	
None													
Impact on Environmental Ratings													
Checked boxes indicate the status of environmental ratings following implementation of this change. If below boxes are checked, there are no changes to the associated environmental ratings.													
	RoHS				ACH			en Stat	us		_	C 62474	
⊠ No C	$oxed{oxed}$ No Change $oxed{oxed}$ No Ch		No Cha	nge		⊠ No ($oxed{\boxtimes}$ No Change			No C	hange		
Changes to product identification resulting from this PCN:													
None													
Product Affected:													
							<u> </u>		T				
CSD19505KCS		CS	SD19506KCS			CSD1	CSD19535KCS			CSD19536KCS			
			_			_			_				



Qualification Results Data Displayed as: Number of lots / Total sample size / Total failed

Туре	Test Name / Condition	Duration	Qual Device: CSD19505KCS	Qual Device: CSD19506KCS	Qual Device: CSD19535KCS	Qual Device: CSD19536KCS
HTGB	High Temp Gate Bias, 80%Vgss (max)	1000 Hours	-	-	-	3/231/0
HTRB	High Temp Reverse Bias, 80%Vdss (max)	1000 Hours	1000 Hours -		-	-
IOL	Intermittent Operational Life	10000 Cycles	-	3/231/0	-	-
AC	Autoclave 121C	96 Hours	-	3/231/0	-	-
FLAM	Flammability (UL 94V-0)	Flam/UL 94V-0	-	3/15/0	-	-
HAST	Biased HAST, 110C/85%RH	264 Hours	-	-	-	3/231/0
HAST	Biased HAST, 110C/85%RH	528 Hours	-	-	-	3/231/0
HTSL	High Temp Storage Bake 150C	1000 Hours	-	3/231/0	-	-
TC	Temperature Cycle, -65/150C	500 Cycles	1/77/0	3/231/0	-	-
YLD	FTY and Bin Summary	-	Pass	Pass	Pass	Pass

⁻ QBS: Qual by Similarity

- CDS. Qual by Similarity
 Preconditioning was performed for Autoclave, Unbiased HAST, THB/Biased HAST, Temperature Cycle, Thermal Shock, and HTSL, as applicable
 The following are equivalent HTOL options based on an activation energy of 0.7eV: 125C/1k Hours, 140C/480 Hours, 150C/300 Hours, and 155C/240 Hours
 The following are equivalent HTSL options based on an activation energy of 0.7eV: 150C/1k Hours, and 170C/420 Hours
 The following are equivalent Temp Cycle options per JESD47: -55C/125C/700 Cycles and -65C/150C/500 Cycles

For questions regarding this notice, e-mails can be sent to the contacts shown below or your local Field Sales Representative.

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